

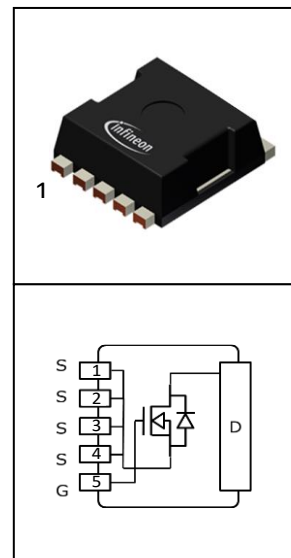
**OptiMOS™ -6 Power-Transistor**

**Product Summary**

$V_{DS}$	40	V
$R_{DS(on),max}$	0.64	m $\Omega$
$I_D$	250	A

**Features**

- OptiMOS™ - power MOSFET for automotive applications
- N-channel - Enhancement mode - Normal Level
- AEC Q101 qualified
- MSL3 up to 260°C peak reflow
- 175°C operating temperature
- Green Product (RoHS compliant)
- 100% Avalanche tested

**PG-HSOF-5-4**


Type	Package	Marking
IAUA250N04S6N006	PG-HSOF-5-4	6N04R6

**Maximum ratings, at  $T_j=25\text{ °C}$ , unless otherwise specified**

Parameter	Symbol	Conditions	Value	Unit
Drain current	$I_D$	$V_{GS}=10V$ , Chip Limitation <sup>1,2)</sup>	450	A
		$V_{GS}=10V$ , DC current <sup>3)</sup>	250	
		$T_a=85\text{ °C}$ , $V_{GS}=10V$ , $R_{thJA}$ on 2s2p <sup>4,5)</sup>	57	
Pulsed drain current <sup>5)</sup>	$I_{D,pulse}$	$T_C=25\text{ °C}$ , $t_p=100\mu s$	1500	
Avalanche energy, single pulse <sup>2)</sup>	$E_{AS}$	$I_D=125A$ , $R_{G,min}=25\Omega$	450	mJ
Avalanche current, single pulse	$I_{AS}$	$R_{G,min}=25\Omega$	125	A
Gate source voltage	$V_{GS}$	-	$\pm 20$	V
Power dissipation	$P_{tot}$	$T_C=25\text{ °C}$	250	W
Operating and storage temperature	$T_j, T_{stg}$	-	-55 ... +175	°C

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
<b>Thermal characteristics<sup>2)</sup></b>						
Thermal resistance, junction - case	$R_{thJC}$	-	-	-	0.6	K/W
Thermal resistance, junction - ambient <sup>4)</sup>	$R_{thJA}$	-	-	22.7	-	

**Electrical characteristics**, at  $T_j=25^\circ\text{C}$ , unless otherwise specified

**Static characteristics**

Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=1\text{mA}$	40	-	-	V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=145\mu\text{A}$	2.2	2.6	3.0	
Zero gate voltage drain current	$I_{DSS}$	$V_{DS}=40V, V_{GS}=0V, T_j=25^\circ\text{C}$	-	-	1	$\mu\text{A}$
		$V_{DS}=40V, V_{GS}=0V, T_j=125^\circ\text{C}^{2)}$	-	-	40	
Gate-source leakage current	$I_{GSS}$	$V_{GS}=20V, V_{DS}=0V$	-	-	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=7V, I_D=100\text{A}$	-	0.54	0.70	m $\Omega$
		$V_{GS}=10V, I_D=100\text{A}$	-	0.47	0.64	

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	

**Dynamic characteristics<sup>2)</sup>**

Input capacitance	$C_{iss}$	$V_{GS}=0V, V_{DS}=25V,$ $f=1MHz$	-	8318	11064	pF
Output capacitance	$C_{oss}$		-	2503	3329	
Reverse transfer capacitance	$C_{rss}$		-	96	144	
Turn-on delay time	$t_{d(on)}$	$V_{DD}=20V, V_{GS}=10V,$ $I_D=125A, R_G=3.5\Omega$	-	14	-	ns
Rise time	$t_r$		-	9	-	
Turn-off delay time	$t_{d(off)}$		-	35	-	
Fall time	$t_f$		-	18	-	

**Gate Charge Characteristics<sup>2)</sup>**

Gate to source charge	$Q_{gs}$	$V_{DD}=20V, I_D=125A,$ $V_{GS}=0 \text{ to } 10V$	-	35	47	nC
Gate to drain charge	$Q_{gd}$		-	24	36	
Gate charge total	$Q_g$		-	127	169	
Gate plateau voltage	$V_{plateau}$		-	4.2	-	V

**Reverse Diode**

Diode continuous forward current <sup>5)</sup>	$I_S$	$T_C=25^\circ C$	-	-	325	A
Diode pulse current <sup>5)</sup>	$I_{S,pulse}$	$T_C=25^\circ C, t_p=100\mu s$	-	-	1940	
Diode forward voltage	$V_{SD}$	$V_{GS}=0V, I_F=125A,$ $T_j=25^\circ C$	-	0.8	1.1	V
Reverse recovery time <sup>2)</sup>	$t_{rr}$	$V_R=20V, I_F=50A,$ $di_F/dt=100A/\mu s$	-	70	-	ns
Reverse recovery charge <sup>2)</sup>	$Q_{rr}$		-	87	-	nC

<sup>1)</sup> Practically the current is limited by overall system design including customer specific PCB.

<sup>2)</sup> The parameter is not subject to production test - verified by characterization.

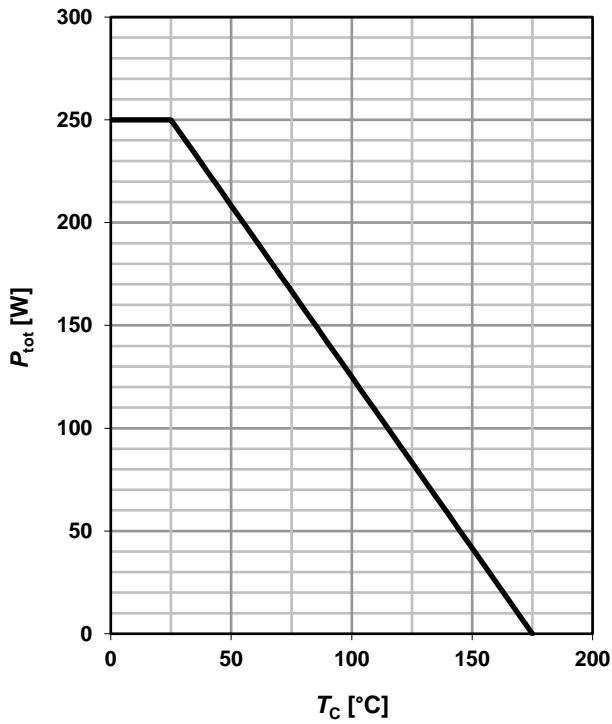
<sup>3)</sup> The product can operate at specified current based on best practice to minimize electromigration at the solder joint. For rare events and inrush currents the value may be exceeded.

<sup>4)</sup> Device on 2s2p FR4 PCB defined in accordance with JEDEC standards (JESD51-5, -7). PCB is vertical in still air.

<sup>5)</sup> The parameter is not subject to production test - verified by design.

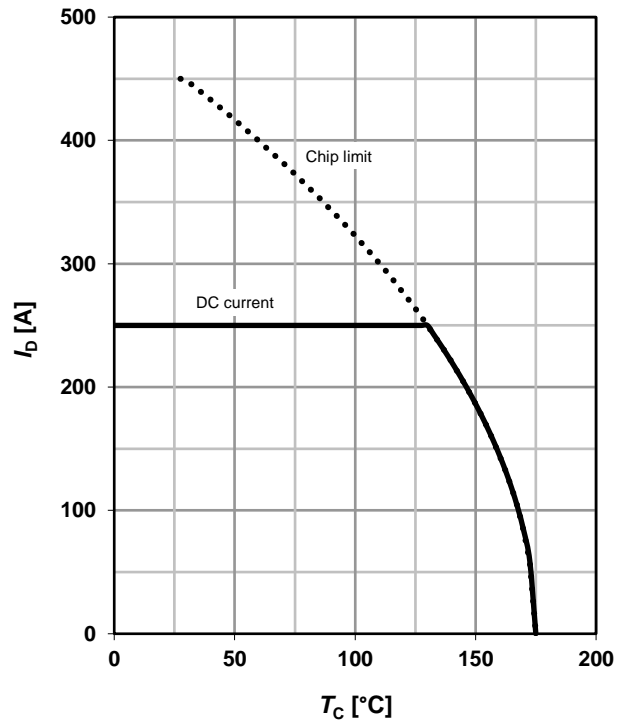
**1 Power dissipation**

$P_{tot} = f(T_C); V_{GS} = 10\text{ V}$



**2 Drain current**

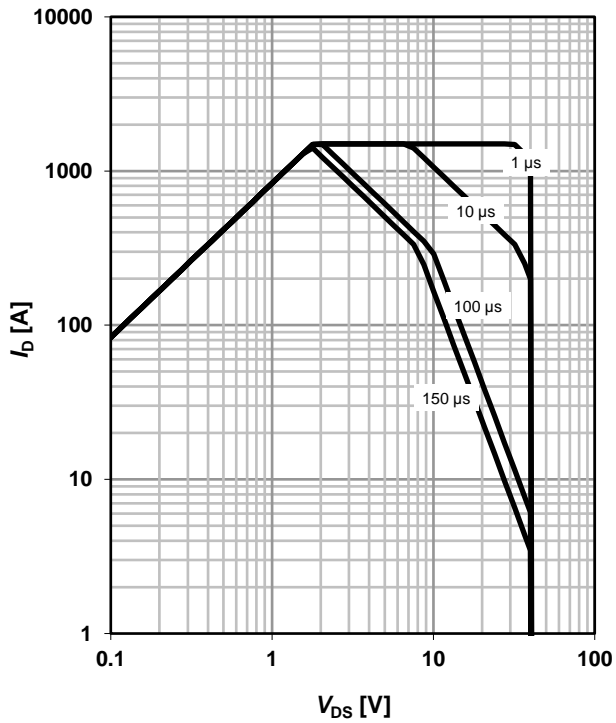
$I_D = f(T_C); V_{GS} = 10\text{ V}$



**3 Safe operating area**

$I_D = f(V_{DS}); T_C = 25\text{ °C}; D = 0$

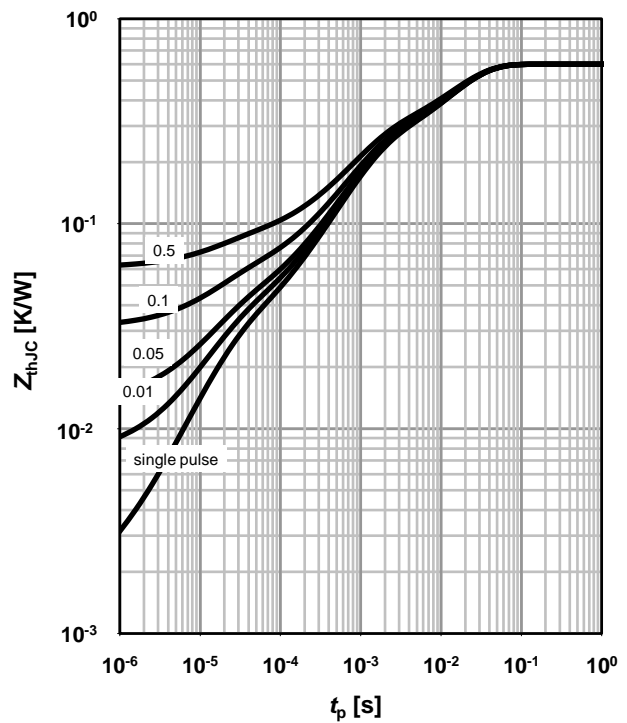
parameter:  $t_p$



**4 Max. transient thermal impedance**

$Z_{thJC} = f(t_p)$

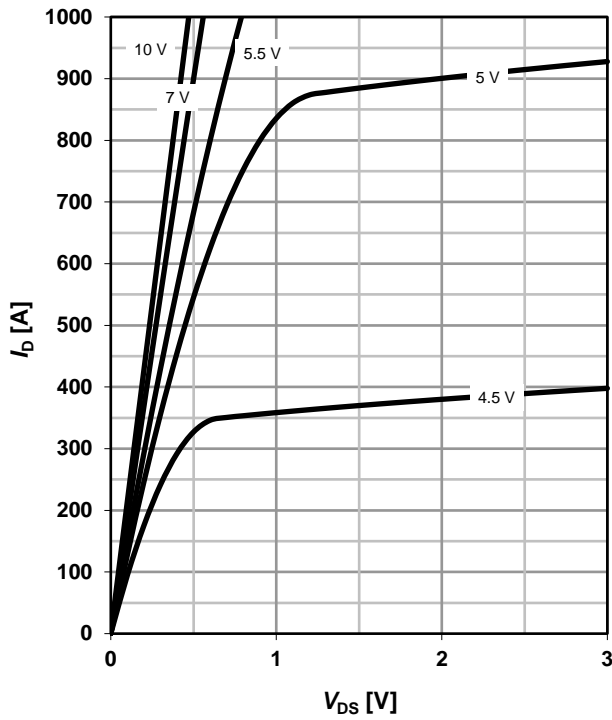
parameter:  $D = t_p/T$



**5 Typ. output characteristics**

$I_D = f(V_{DS}); T_j = 25\text{ }^\circ\text{C}$

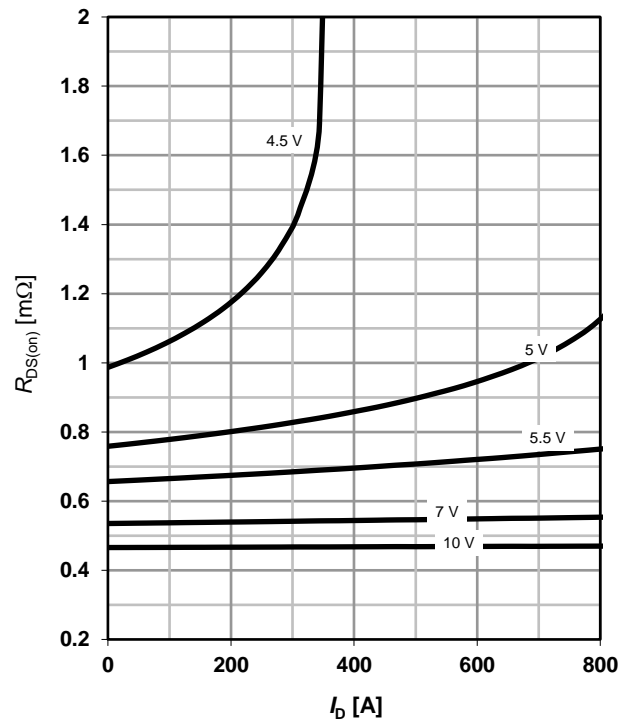
parameter:  $V_{GS}$



**6 Typ. drain-source on-state resistance**

$R_{DS(on)} = f(I_D); T_j = 25\text{ }^\circ\text{C}$

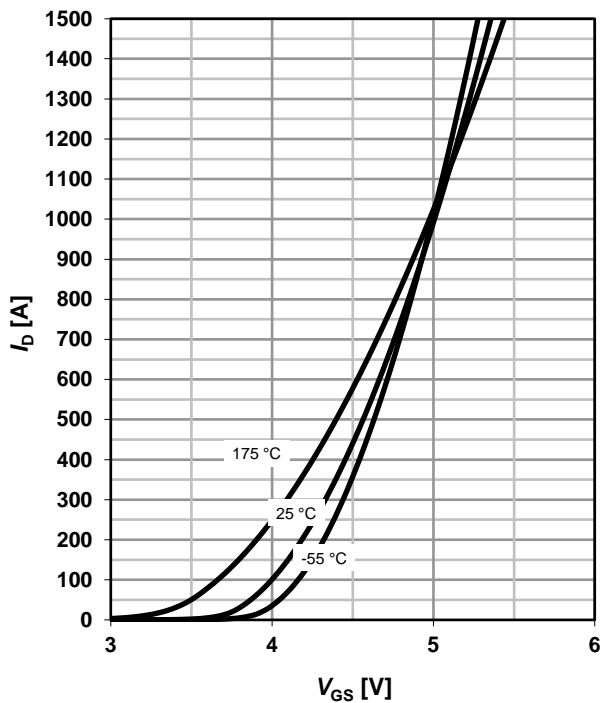
parameter:  $V_{GS}$



**7 Typ. transfer characteristics**

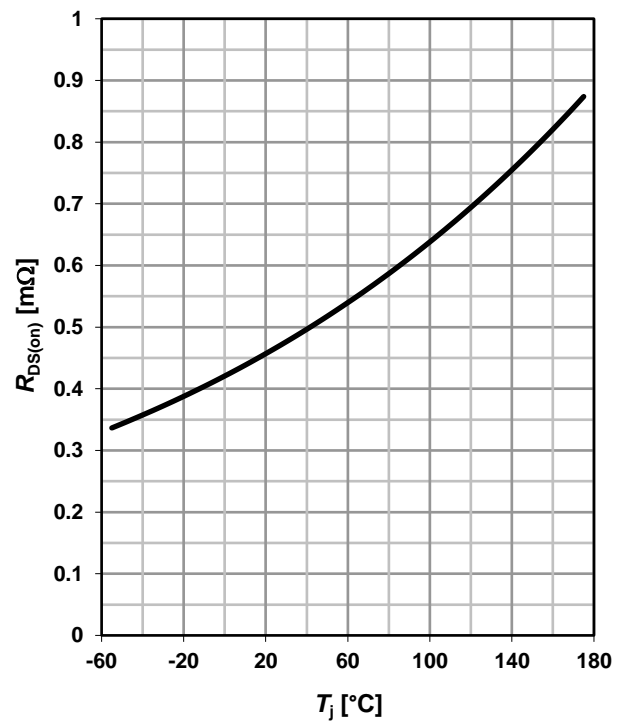
$I_D = f(V_{GS}); V_{DS} = 6\text{ V}$

parameter:  $T_j$



**8 Typ. drain-source on-state resistance**

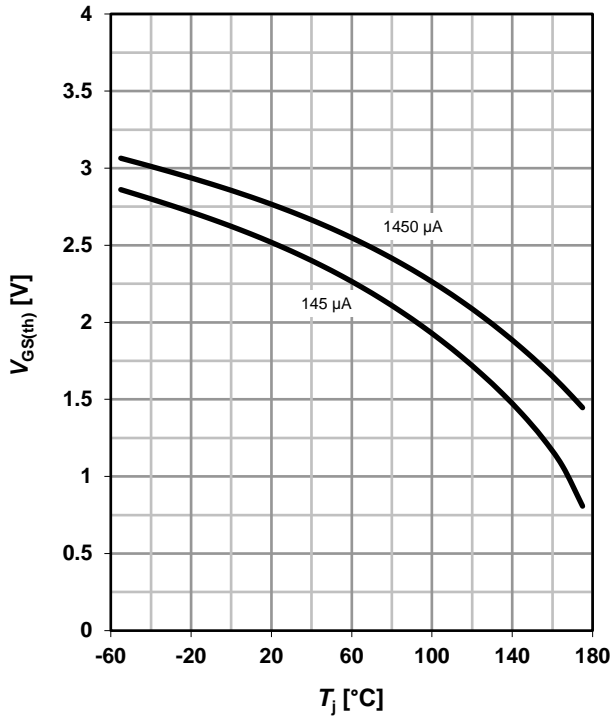
$R_{DS(on)} = f(T_j); I_D = 125\text{ A}; V_{GS} = 10\text{ V}$



**9 Typ. gate threshold voltage**

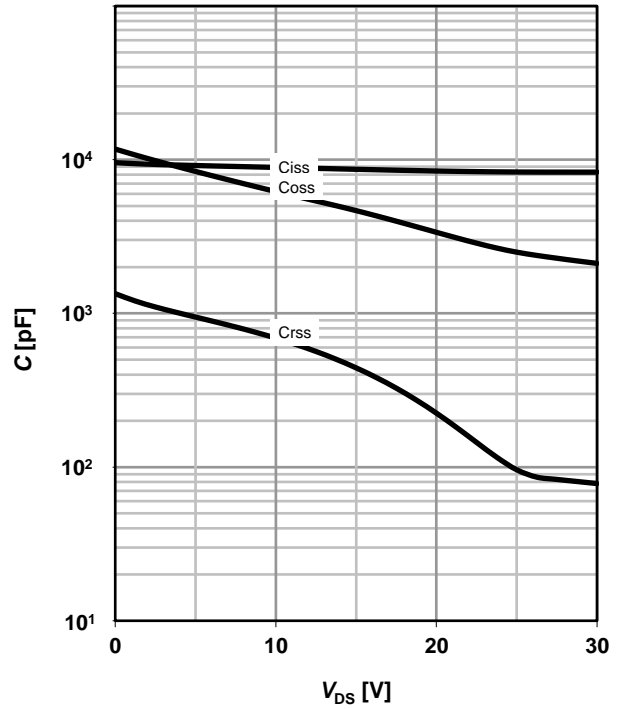
$V_{GS(th)} = f(T_j); V_{GS} = V_{DS}$

parameter:  $I_D$



**10 Typ. capacitances**

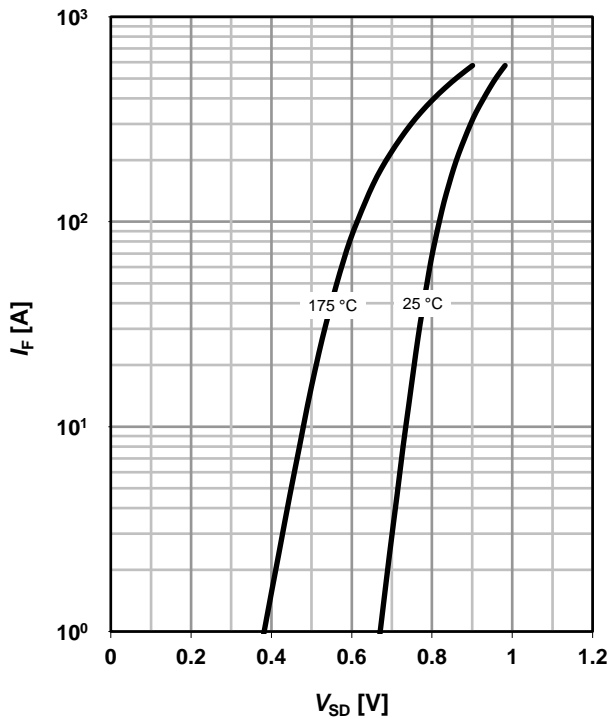
$C = f(V_{DS}); V_{GS} = 0 V; f = 1 MHz$



**11 Typical forward diode characteristics**

$I_F = f(V_{SD})$

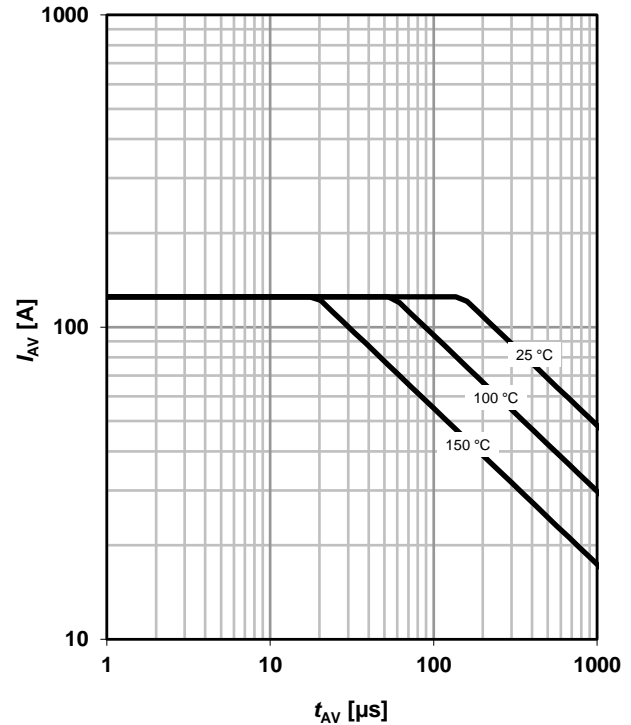
parameter:  $T_j$



**12 Avalanche characteristics**

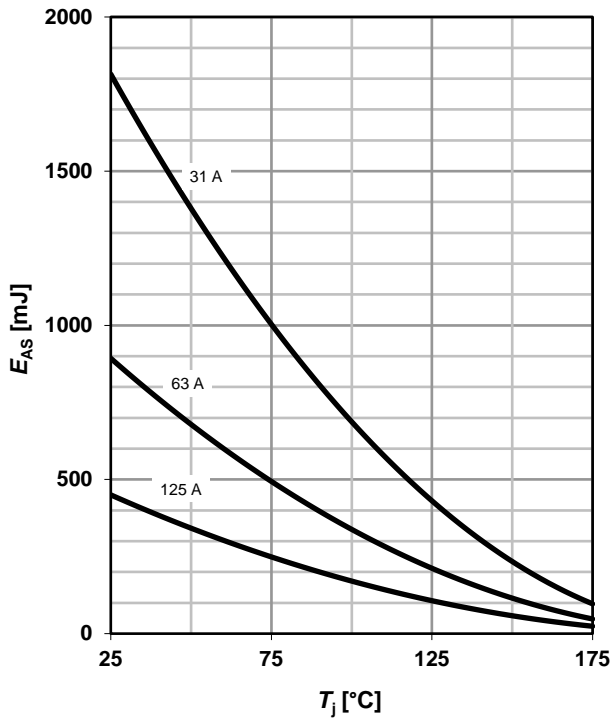
$I_{AS} = f(t_{AV})$

parameter:  $T_{j(start)}$

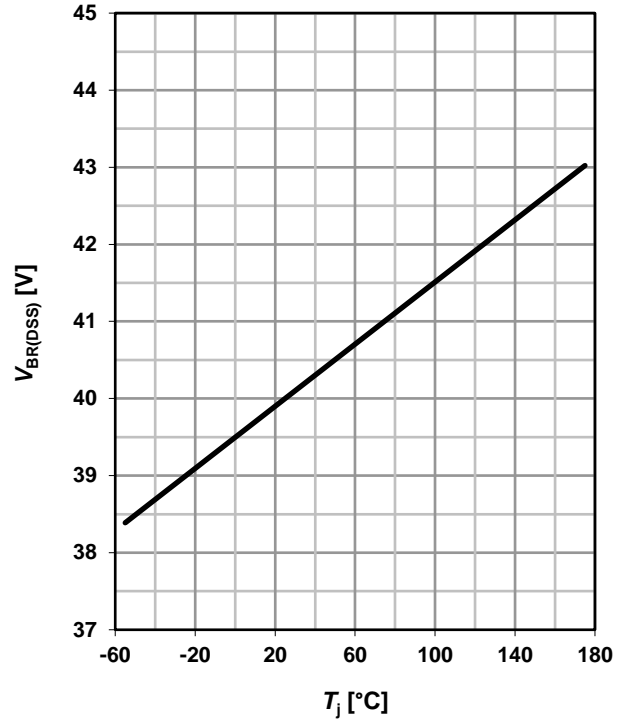


**13 Avalanche energy**

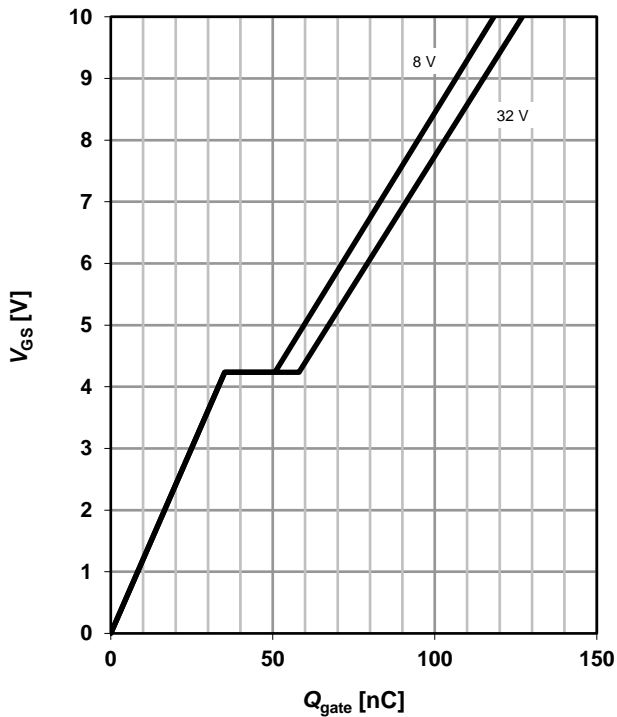
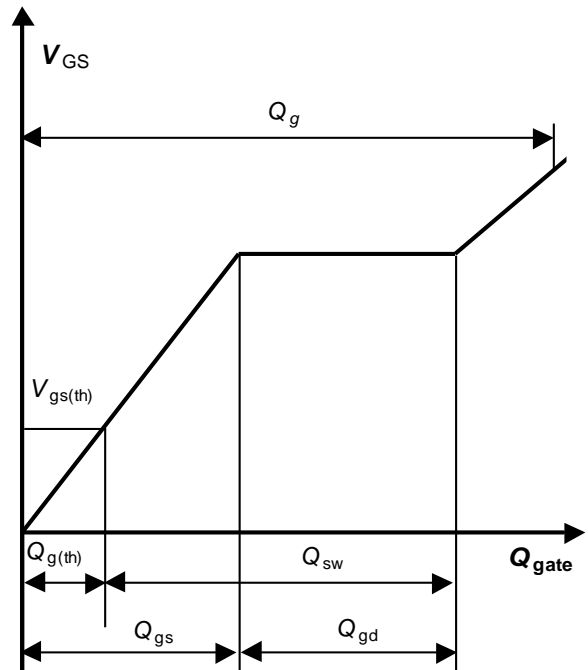
$$E_{AS} = f(T_j)$$


**14 Drain-source breakdown voltage**

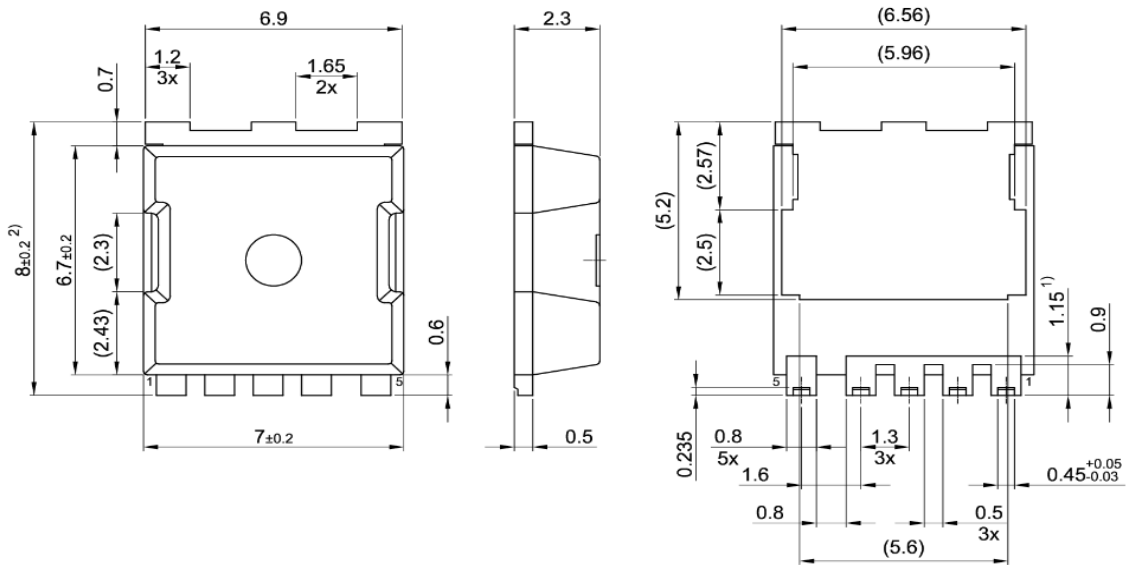
$$V_{BR(DSS)} = f(T_j); I_D = 1 \text{ mA}$$


**15 Typ. gate charge**

$$V_{GS} = f(Q_{gate}); I_D = 250 \text{ A pulsed}$$

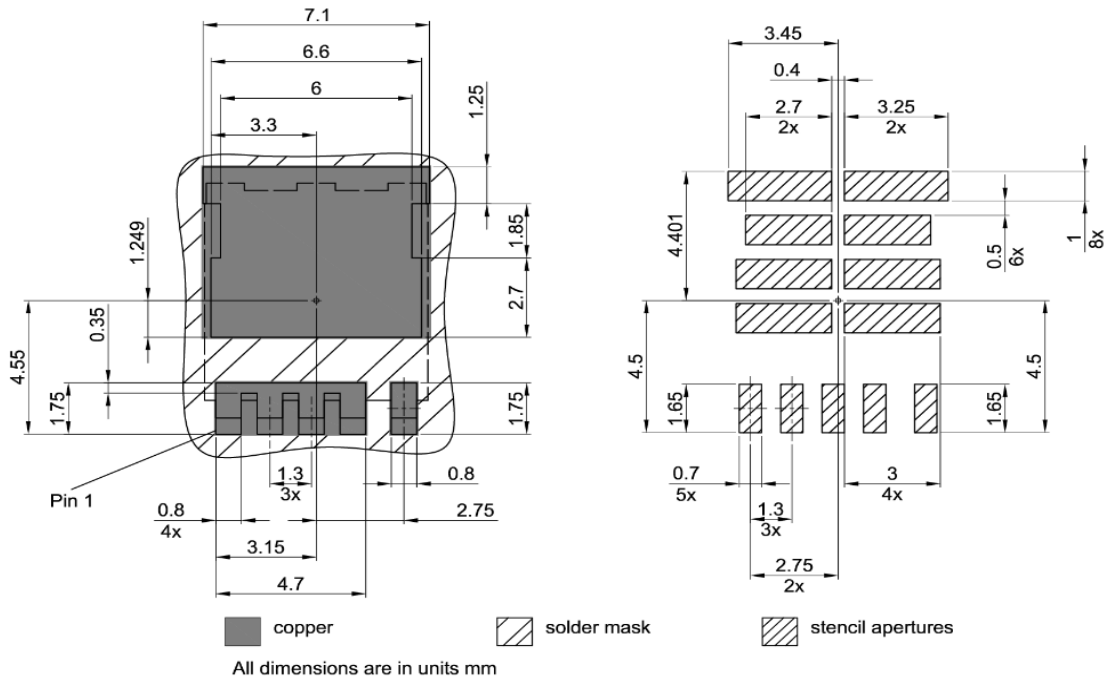
 parameter:  $V_{DD}$ 

**16 Gate charge waveforms**


**PG-HSOF-5: Outline**



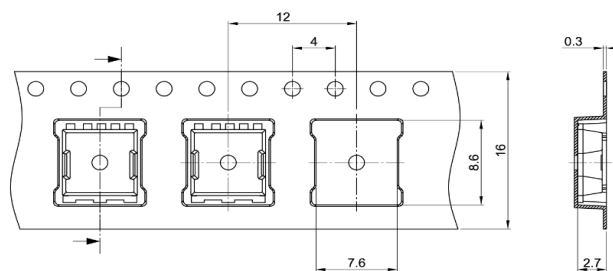
1) Lead length up to anti flash profile; mold flashes excluded  
 2) Excluding burr  
 All dimensions are in units mm  
 The drawing is in compliance with ISO 128-30, Projection Method 1 [ ]

**Footprint**



**Dimensions in mm**

**Packaging**



All dimensions are in units mm  
 The drawing is in compliance with ISO 128-30, Projection Method 1 [ ]



**Published by**  
**Infineon Technologies AG**  
**81726 Munich, Germany**

**© Infineon Technologies AG 2020**  
**All Rights Reserved.**

#### **Legal Disclaimer**

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

#### **Information**

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office ([www.infineon.com](http://www.infineon.com)).

#### **Warnings**

Due to technical requirements, components may contain dangerous substances.  
For information on the types in question, please contact the nearest Infineon Technologies Office.  
Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life.  
If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.



## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for [MOSFET](#) category:*

*Click to view products by [Infineon](#) manufacturer:*

Other Similar products are found below :

[614233C](#) [648584F](#) [IRFD120](#) [JANTX2N5237](#) [FCA20N60\\_F109](#) [FDZ595PZ](#) [2SK2545\(Q,T\)](#) [405094E](#) [423220D](#) [TPCC8103,L1Q\(CM](#)  
[MIC4420CM-TR](#) [VN1206L](#) [614234A](#) [715780A](#) [NTNS3166NZT5G](#) [SSM6J414TU,LF\(T](#) [751625C](#) [BUK954R8-60E](#) [GROUP A 5962-](#)  
[8877003PA](#) [NTE6400](#) [SQJ402EP-T1-GE3](#) [2SK2614\(TE16L1,Q\)](#) [2N7002KW-FAI](#) [DMN1017UCP3-7](#) [EFC2J004NUZTDG](#) [ECH8691-TL-W](#)  
[FCAB21350L1](#) [P85W28HP2F-7071](#) [DMN1053UCP4-7](#) [NTE221](#) [NTE222](#) [NTE2384](#) [NTE2903](#) [NTE2941](#) [NTE2945](#) [NTE2946](#) [NTE2960](#)  
[NTE2967](#) [NTE2969](#) [NTE2976](#) [NTE6400A](#) [NTE2910](#) [NTE2916](#) [NTE2956](#) [NTE2911](#) [DMN2080UCB4-7](#) [TK10A80W,S4X\(S](#)  
[SSM6P54TU,LF](#) [SSM6P69NU,LF](#) [DMP22D4UFO-7B](#)